

3MHz CMOS Rail-to-Rail IO Opamps

Features

Single-Supply Operation from +2.1V ~ +5.5V

• Rail-to-Rail Input / Output

Gain-Bandwidth Product: 3MHz (Typ)

Low Input Bias Current: 1pA (Typ)

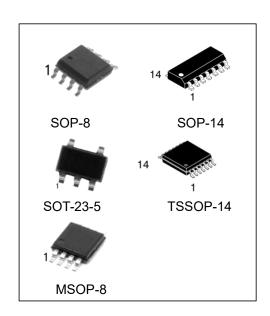
Low Offset Voltage: 3.5mV (Max)

Quiescent Current: 250µA per Amplifier (Typ)

• Operating Temperature: -40°C ~ +125°C

Small Package:

OPA314 Available in SOP-8 and SOT23-5 Packages
OPA2314 Available in SOP-8 and MSOP-8 Packages
OPA4314 Available in SOP-14 and TSSOP-14 Packages



Ordering Information

DEVICE	Package Type	MARKING	Packing	Packing Qty
OPA314M/TR	SOP-8	OPA314	REEL	2500pcs/reel
OPA314M5/TR	SOT-23-5	A314	REEL	3000pcs/reel
OPA2314M/TR	SOP-8	OPA2314,A2314	REEL	2500pcs/reel
OPA2314MM/TR	MSOP-8	A2314	REEL	3000pcs/reel
OPA4314M/TR	SOP-14	OPA4314	REEL	2500pcs/reel
OPA4314MT/TR	TSSOP-14	OPA4314,A4314	REEL	2500pcs/reel



General Description

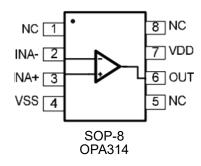
The OPA314/2314/4314 have a high gain-bandwidth product of 3MHz, a slew rate of 1.66V/μs, and a quiescent current of 250μA per amplifier at 5V. The OPA314/2314/4314 are designed to provide optimal performance in low voltage and low noise systems. They provide rail-to-rail output swing into heavy loads. The input common mode voltage range includes ground, and the maximum input offset voltage is 3.5mV for OPA314/2314/4314. They are specified over the extended industrial temperature range (-40°C to+125°C). The operating range is from 2.1V to 5.5V.The OPA314 dual is available in Green SOT23-5 and SOP-8 packages. The OPA4314 Quad is available in Green SOP-14 and TSSOP-14 packages.

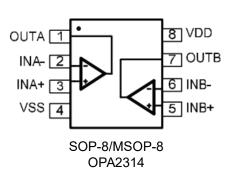
Applications

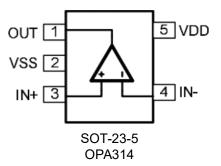
- Sensors
- Active Filters
- Cellular and Cordless Phones
- Laptops and PDAs

- Audio
- Handheld Test Equipment
- Battery-Powered Instrumentation
- A/D Converters

Pin Configuration







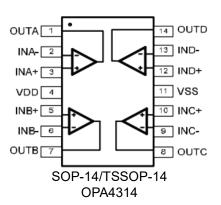


Figure 1. Pin Assignment Diagram



Absolute Maximum Ratings

Condition	Min	Max	
Power Supply Voltage (VDD to Vss)	-0.5V	+7.5V	
Analog Input Voltage (IN+ or IN-)	Vss-0.5V	V _{DD} +0.5V	
PDB Input Voltage	Vss-0.5V	+7V	
Operating Temperature Range	-40°C	+125°C	
Junction Temperature	-	+160°C	
Storage Temperature Range	-55°C	+150°C	
Lead Temperature (soldering, 10sec)	-	245°C	
Package Thermal Resistance (TA=+25℃)			
SOP-8, θJA	-	125°C/W	
SOT23-5, θJA	-	190°C/W	
MSOP-8, θJA	-	216°C/W	
ESD Susceptibility			
НВМ	-	8KV	
MM	-	400V	

Note: Stress greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions outside those indicated in the operational sections of this specification are not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.



Electrical Characteristics

(At Vs=5V, T_A = +25 $^{\circ}\!\!\mathrm{C}$, V_{CM} = V_S/2, R_L = 600 $\!\Omega$, unless otherwise noted.)

				OPA	314/2314	1/4314		
PARAMETER	CONDITIONS	TYP		MIN/MA	X OVER	TEMPER	RATURE	
		+25℃	+25℃	0℃ to70℃	-40℃ to85℃	-40 ℃ to125℃	UNITS	MIN MAX
INPUT CHARACTERISTICS								
Input Offset Voltage (VOS)		0.8	3.5	3.9	4.3	4.6	mV	MAX
Input Bias Current (IB)		1					pА	TYP
Input Offset Current (IOS)		1					pА	TYP
Input Common Mode Voltage Range (VCM)	VS = 5.5V	-0.1 to					V	TYP
		+5.6						
Common Mode Rejection Ratio (CMRR)	VS = 5.5V, VCM = -0.1V to 4V	82	65	64	64	63	dB	MIN
	VS = 5.5V, VCM = -0.1V to 5.6V	71					dB	MIN
Open-Loop Voltage Gain (AOL)	RL = 600Ω,VO = 0.15V to 4.85V	90	80	76	75	68	dB	MIN
	RL = $10k\Omega$, VO = 0.05V to 4.95V	100					dB	MIN
Input Offset Voltage Drift ($\Delta VOS/\Delta T$)		2.4					μV/℃	TYP
OUTPUT CHARACTERISTICS								
Output Voltage Swing from Rail	$R_L = 600\Omega$	0.1					V	TYP
	RL = 10kΩ	0.015					V	TYP
Output Current (IOUT)		53	49	45	40	35	mA	MIN
Closed-Loop Output Impedance	f = 100kHz, G = 1	10					Ω	TYP
POWER-DOWN DISABLE								
Turn-On Time		4					μs	TYP
Turn-Off Time		1.2					μs	TYP
DISABLE Voltage-Off			0.8				V	MAX
DISABLE Voltage-On			2				V	MIN
POWER SUPPLY								
Operating Voltage Range			2.1	2.1	2.1	2.1	V	MIN
			5.5	5.5	5.5	5.5	V	MAX
Power Supply Rejection Ratio (PSRR)	Vs = +2.5V to +5.5V							
	VCM = (-VS) + 0.5V	91	74	72	72	68	dB	MIN
Quiescent Current/Amplifier (IQ)	IOUT = 0	250	350	427	450	515	μA	MAX
Supply Current when Disabled		90					nA	MAX
(OPA314N Only)								



Electrical Characteristics

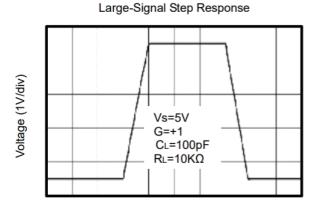
(At Vs=5V, T_A = +25°C, V_{CM} = VS/2, R_L = 600 Ω , unless otherwise noted.)

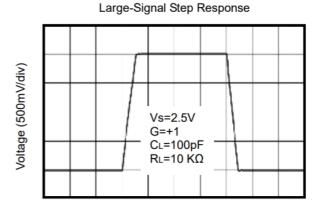
		OPA314/2314/4314								
PARAMETER	CONDITIONS	TYP		MIN/MAX OVER TEMPERATURE						
		+25℃	+25℃	0℃ to 70℃	-40℃ to 85℃	-40℃ to	UNITS	MIN MAX		
DYNAMIC PERFORMANCE				700	03 C	1250		IVIAX		
Gain-Bandwidth Product (GBP)	RL = 10kΩ, CL = 100pF	3					MHz	TYP		
Phase Margin (φ _O)	RL = 10kΩ, CL = 100pF	50					Degrees	TYP		
Full Power Bandwidth (BWP)	$<$ 1% distortion, R _L = 600 Ω	50					kHz	TYP		
Slew Rate (SR)	G = +1, 2V Step, RL = 10kΩ	1.66					V/µs	TYP		
Settling Time to 0.1% (ts)	G = +1, 2V Step, R _L = 600Ω	0.5					μs	TYP		
Overload Recovery Time	V _{IN} ·Gain = VS, R _L = 600Ω	4.5					μs	TYP		
NOISE PERFORMANCE										
Voltage Noise Density (en)	f = 1kHz	18					$\text{nV}\sqrt{\text{Hz}}$	TYP		
Current Noise Density (in)	f = 1kHz	4.5					fA√Hz	TYP		



Typical Performance characteristics

(At Vs=5V, T_A = +25°C, V_{CM} = Vs/2, R_L = 600 Ω , unless otherwise noted.)

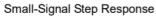


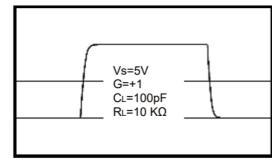


Time (2µs/div)

Time (2µs/div)

Small-Signal Step Response



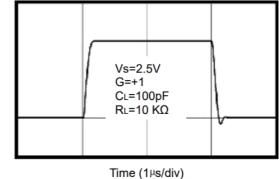


Voltage (50mV/div)

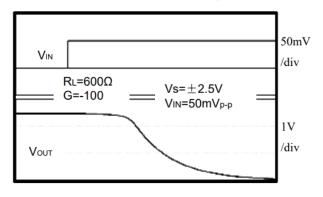
Vs=2.5V G=+1

Voltage (50mV/div)

Time (1µs/div)

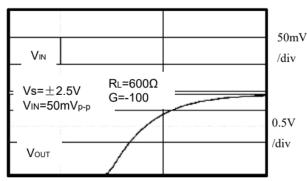


Positive Overload Recovery



Time (5µs/div)

Negative Overload Recovery



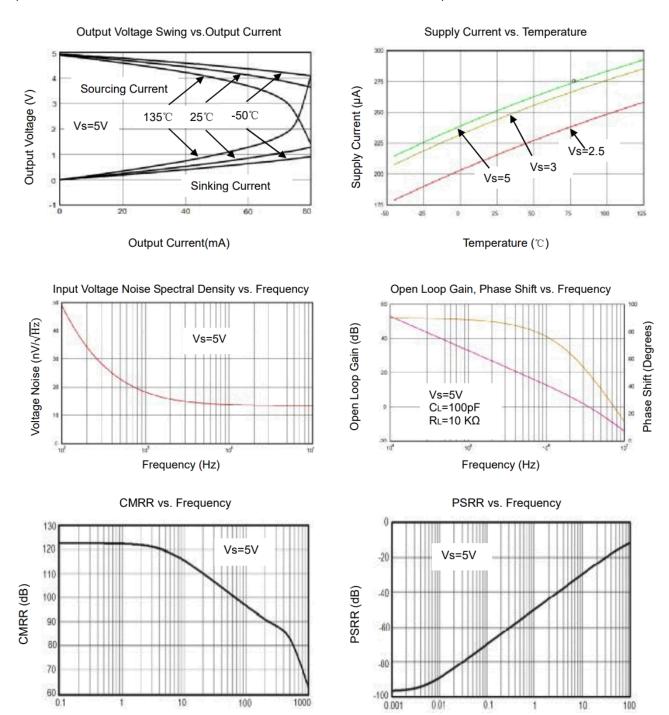
Time (5µs/div)

6 / 16



Typical Performance characteristics

(At Vs=5V, $T_A = +25^{\circ}C$, $V_{CM} = VS/2$, $R_L = 600\Omega$, unless otherwise noted.)



Frequency (kHz)

Frequency (kHz)



Application Note

Size

OPA314/2314/4314 series op amps are unity-gain stable and suitable for a wide range of general-purpose applications. The small footprints of the OPA314/2314/4314 series packages save space on printed circuit boards and enable the design of smaller electronic products.

Power Supply Bypassing and Board Layout

OPA314/2314/4314 series operates from a single 2.1V to 5.5V supply or dual ± 1.05 V to ± 2.75 V supplies. For best performance, a 0.1μ F ceramic capacitor should be placed close to the VDD pin in single supply operation. For dual supply operation, both VDD and VSS supplies should be bypassed to ground with separate 0.1μ F ceramic capacitors.

Low Supply Current

The low supply current (typical 250µA per channel) of OPA314/2314/4314 series will help to maximize battery life. They are ideal for battery powered systems.

Operating Voltage

OPA314/2314/4314 series operate under wide input supply voltage (2.1V to 5.5V). In addition, all temperature specifications apply from -40 $^{\circ}$ C to +125 $^{\circ}$ C. Most behavior remains unchanged throughout the full operating voltage range. These guarantees ensure operation throughout the single Li-lon battery lifetime.

Rail-to-Rail Input

The input common-mode range of OPA314/2314/4314 series extends 100mV beyond the supply rails (VSS-0.1V to VDD+0.1V). This is achieved by using complementary input stage. For normal operation, inputs should be limited to this range.

Rail-to-Rail Outpu

Rail-to-Rail output swing provides maximum possible dynamic range at the output. This is particularly important when operating in low supply voltages. The output voltage of OPA314/2314/4314 series can typically swing to less than 2mV from supply rail in light resistive loads (>100k Ω), and 60mV of supply rail in moderate resistive loads (10k Ω).

Capacitive Load Tolerance

The OPA314/2314/4314 family is optimized for bandwidth and speed, not for driving capacitive loads. Output capacitance will create a pole in the amplifier's feedback path, leading to excessive peaking and potential oscillation. If dealing with load capacitance is a requirement of the application, the two strategies to consider are (1) using a small resistor in series with the amplifier's output and the load capacitance and (2) reducing the bandwidth of the amplifier's feedback loop by increasing the overall noise gain. Figure 2. shows a unity gain follower using the series resistor strategy. The resistor isolates the output from the capacitance and, more importantly, creates a zero in the feedback path that compensates for the pole created by the output capacitance.



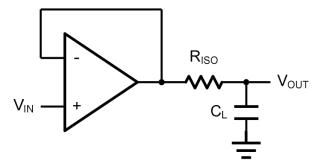


Figure 2. Indirectly Driving a Capacitive Load Using Isolation Resistor

The bigger the RISO resistor value, the more stable VOUT will be. However, if there is a resistive load RL in parallel with the capacitive load, a voltage divider (proportional to RISO/RL) is formed, this will result in a gain error.

The circuit in Figure 3 is an improvement to the one in Figure 2. RF provides the DC accuracy by feed-forward the VIN to RL. CF and RISO serve to counteract the loss of phase margin by feeding the high frequency component of the output signal back to the amplifier's inverting input, thereby preserving the phase margin in the overall feedback loop. Capacitive drive can be increased by increasing the value of CF. This in turn will slow down the pulse response.

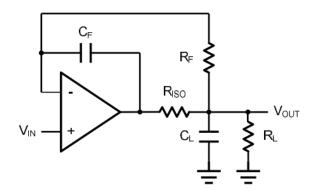


Figure 3. Indirectly Driving a Capacitive Load with DC Accuracy



Typical Application Circuits

Differential amplifier

The differential amplifier allows the subtraction of two input voltages or cancellation of a signal common the two inputs. It is useful as a computational amplifier in making a differential to single-end conversion or in rejecting a common mode signal. Figure 4. shown the differential amplifier using OPA314/2314/4314.

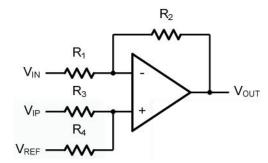


Figure 4. Differential Amplifier

$$V_{OUT} = (\frac{R_1 + R_2}{R_3 + R_4}) \frac{R_4}{R_1} V_{IN} - \frac{R2}{R1} V_{IP} + (\frac{R_1 + R_2}{R_3 + R_4}) \frac{R_3}{R_1} V_{REF}$$

If the resistor ratios are equal (i.e. R1=R3 and R2=R4), then

$$V_{OUT} = \frac{R_2}{R_1} (V_{IP} - V_{IN}) + V_{REF}$$

Low Pass Active Filter

The low pass active filter is shown in Figure 5. The DC gain is defined by -R2/R1. The filter has a -20dB/decade roll-off after its corner frequency $fC=1/(2\pi R3C1)$.

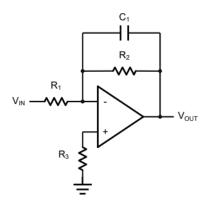


Figure 5. Low Pass Active Filter



Instrumentation Amplifier

The triple OPA314/2314/4314 can be used to build a three-op-amp instrumentation amplifier as shown in Figure 6. The amplifier in Figure 6 is a high input impedance differential amplifier with gain of R2/R1. The two differential voltage followers assure the high input impedance of the amplifier.

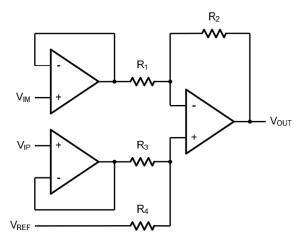
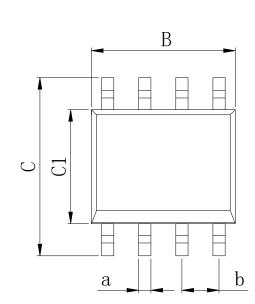


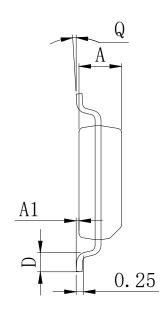
Figure 6. Instrument Amplifier



Physical Dimensions

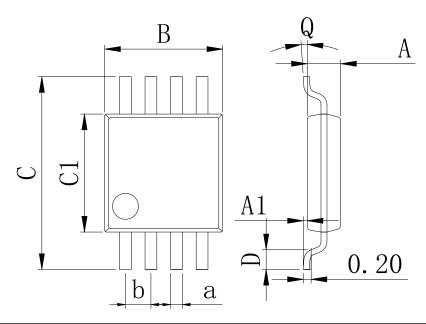
SOP-8





Dimensions In Millimeters(SOP-8)									
Symbol:	Α	A1	В	С	C1	D	Q	а	b
Min:	1.35	0.05	4.90	5.80	3.80	0.40	0°	0.35	1 27 DCC
Max:	1.55	0.20	5.10	6.20	4.00	0.80	8°	0.45	1.27 BSC

MSOP-8

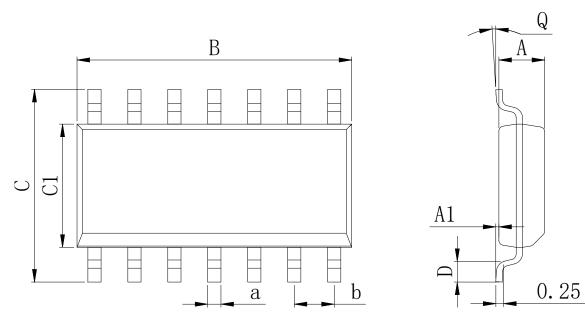


Dimensions In Millimeters(MSOP-8)									
Symbol:	Α	A1	В	С	C1	D	Q	а	b
Min:	0.80	0.05	2.90	4.75	2.90	0.35	0°	0.25	0.65 BSC
Max:	0.90	0.20	3.10	5.05	3.10	0.75	8°	0.35	0.00 BSC



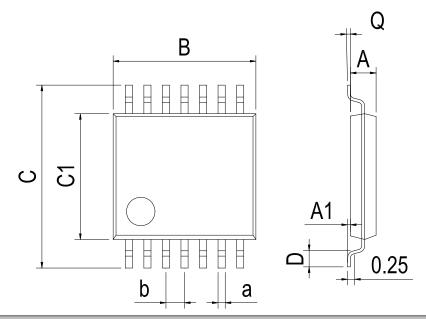
Physical Dimensions

SOP-14



Dimensions In Millimeters(SOP-14)									
Symbol:	А	A1	В	С	C1	D	Q	а	b
Min:	1.35	0.05	8.55	5.80	3.80	0.40	0°	0.35	1 27 DCC
Max:	1.55	0.20	8.75	6.20	4.00	0.80	8°	0.45	- 1.27 BSC

TSSOP-14

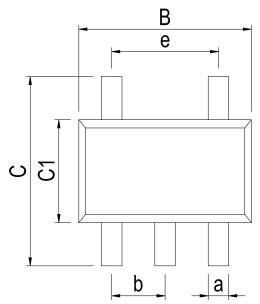


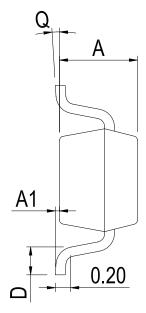
Dimensions In Millimeters(TSSOP-14)										
Symbol:	Α	A1	В	С	C1	D	Q	а	b	
Min:	0.85	0.05	4.90	6.20	4.30	0.40	0°	0.20	0.05.000	
Max:	0.95	0.20	5.10	6.60	4.50	0.80	8°	0.25	0.65 BSC	



Physical Dimensions

SOT-23-5





Dimensions In Millimeters(SOT-23-5)										
Symbol:	Α	A1	В	С	C1	D	Q	а	b	е
Min:	1.05	0.00	2.82	2.65	1.50	0.30	0°	0.30	0.95 BSC	1 00 BCC
Max:	1.15	0.15	3.02	2.95	1.70	0.60	8°	0.40	0.95 BSC	1.90 BSC



Revision History

DATE	REVISION	PAGE
2016-4-5	New	1-16
2023-7-24	Update encapsulation type、Update Lead Temperature	1、3



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